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Honeywell Docket No. JM36365 CIP/DIV - 4962  
Practitioner Docket No. 7220145001-3222000

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231

Inventor: My Nguyen

Examiner:

Serial No: Div. of 10/047617

Art Unit:

Filed: January 14, 2002

For: Thermal Interface Materials

PRELIMINARY AMENDMENT

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Please enter the following preliminary amendment:

IN THE CLAIMS

Please cancel all allowed claims (1-31) and add the following claims addressing subject matter in application serial number 10/047617:

- ~~32~~<sup>1</sup> A gel material comprising at least one thermally conductive filler, at least one rubber compound crosslinked to at least one amine resin.
- ~~33~~<sup>2</sup> The gel material of claim ~~33~~<sup>1</sup>, wherein the material is a thermal interface material.
- ~~34~~<sup>3</sup> The gel material of claim ~~32~~<sup>1</sup>, further comprising at least one phase change material.
- ~~35~~<sup>4</sup> The gel material of claim ~~32~~<sup>1</sup>, wherein the at least one rubber compound is crosslinked to the at least one amine resin by at least one terminal hydroxy group on the rubber compound.